

IN THE U. S. PATENT AND TRADEMARK OFFICE

In re application of

Kiyohito HIROMITSU et al.

Conf. 6750

Application No. 10/590,243

Group 1791

Filed August 22, 2006

Examiner BLADES, John A.

MOLD CONDITIONING SHEET AND METHOD OF MOLD CONDITIONING

AMENDMENT

Assistant Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

August 13, 2009

Sir:

Responsive to the Office Action mailed May 13, 2009,
please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing
of claims which begins on page 2 of this paper.

Remarks begin on page 4 of this paper.

An **Appendix** is attached which follows the signature
page of this paper.